

## Electronic Acknowledgement Receipt

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| <b>Application Number:</b>                  | 10598717  |
| <b>International Application Number:</b>    |   |
| <b>Confirmation Number:</b>                 | 9262  |
| <b>Title of Invention:</b>                  | Polishing pad and semiconductor device manufacturing method |
| <b>First Named Inventor/Applicant Name:</b> | Tetsuo Shimomura  |
| <b>Customer Number:</b>                     | 20995   |
| <b>Filer:</b>                               | Katsuhiro Arai/Wayne Mahoney                                |
| <b>Filer Authorized By:</b>                 | Katsuhiro Arai  |
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| <b>Application Type:</b>                    | U.S. National Stage under 35 USC 371                        |

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### File Listing:

| Document Number | Document Description | File Name                   | File Size(Bytes) /Message Digest                    | Multi Part /.zip | Pages (if appl.) |
|-----------------|----------------------|-----------------------------|---|------------------|------------------|
| 1               |                      | Amendment_UNIU40-017APC.pdf | 377166<br>4090965aa95d59c906cf8599b0d5af<br>d592a56 | yes              | 9                |

| Multipart Description/PDF files in .zip description |       |     |  |
|---|-------|-----|--|
| Document Description                                | Start | End |  |
| Amendment - After Non-Final Rejection               | 1     | 1   |  |
| Claims  | 2     | 6   |  |
| Applicant Arguments/Remarks Made in an Amendment    | 7     | 9   |  |

**Warnings:**

**Information:**

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**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.